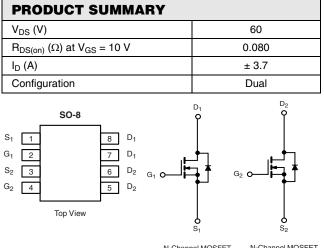




## Automotive Dual N-Channel 60 V (D-S) 175 °C MOSFET



#### FEATURES

- TrenchFET<sup>®</sup> Power MOSFET
- Package with Low Thermal Resistance

#### **AEC-Q101 RELIABILITY**

- Passed all AEC-Q101 Reliability Testing
- Characterization Ongoing



COMPLIANT

# S1 S2 N-Channel MOSFET N-Channel MOSFET ORDERING INFORMATION Package SO-8 Lead (Pb)-free SQ9945AEY-T1-E3 SnPb SQ9945AEY-T1

<b>ABSOLUTE MAXIMUM RATINGS</b> $T_C = 25 \degree C$ , unless otherwise noted							
PARAMETER		SYMBOL	LIMIT	UNIT			
Drain-Source Voltage		V <sub>DS</sub>	60	V			
Gate-Source Voltage		V <sub>GS</sub>	± 20				
Continuous Drain Current <sup>a</sup>	T <sub>C</sub> = 25 °C	1	- 3.7	А			
	T <sub>C</sub> = 70 °C	I <sub>D</sub>	- 3.2				
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	2	~			
Pulsed Drain Current <sup>b</sup>		I <sub>DM</sub>	25				
Single Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	-	mJ			
Single Pulse Avalanche Current		I <sub>AS</sub>	-	А			
Maximum Power Dissipation <sup>b</sup>	T <sub>C</sub> = 25 °C	P <sub>D</sub>	2.4	W			
	T <sub>A</sub> = 70 °C		1.7	vv			
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C			

THERMAL RESISTANCE RATINGS								
PARAMETER		SYMBOL	LIMIT	UNIT				
Junction-to-Ambient	PCB Mount <sup>c</sup>	R <sub>thJA</sub>	-	°C/W				
Junction-to-Case (Drain)		R <sub>thJC</sub>	-	0/11				

#### Notes

a. Package limited.

b. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

c. When mounted on 1" square PCB (FR-4 material).

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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<b>SPECIFICATIONS</b> $T_C = 25 \circ C$	, unless other	wise noted					
PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	•						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$		-	-	-	v
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$		-	3.0	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	-	± 100	nA
Zero Gate Voltage Drain Current		$V_{GS} = 0 V$	V <sub>DS</sub> = 60 V	-	-	1.0	μΑ
	I <sub>DSS</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = 60 V	-	-	10	
		$V_{GS} = 0 V$	$V_{DS} = 60 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	-	
On-State Drain Currenta	I <sub>D(on)</sub>	V <sub>GS</sub> = 10 V	$V_{DS} \ge 5 V$	20	-	-	Α
Drain-Source On-State Resistance <sup>a</sup>		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 3.7 A	-	0.060	0.080	Ω
	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	$I_D = 30 \text{ A},  \text{T}_\text{J} = 125 \ ^\circ\text{C}$	-	-	-	
		V <sub>GS</sub> = 10 V	$I_D = 30 \text{ A},  \text{T}_\text{J} = 175 \ ^\circ\text{C}$	-	-	-	
Forward Transconductance <sup>a</sup>	<b>g</b> fs	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 3.7 A		-	-	11	S
Dynamic <sup>b</sup>	·						
Input Capacitance	C <sub>iss</sub>		V <sub>DS</sub> = 25 V, f = 1 MHz	-	-	-	pF
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$		-	-	-	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	-	-	
Total Gate Charge <sup>c</sup>	Qg		$V_{DS} = 30 \text{ V}, \text{ I}_{D} = 3.7 \text{ A}$	-	11	20	nC
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		-	2	-	
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			-	2	-	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>	$V_{DD} = 30 \text{ V}, \text{ R}_{\text{L}} = 30 \Omega$ $\text{I}_{\text{D}} \cong 1 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 6 \Omega$		-	9	20	- ns
Rise Time <sup>c</sup>	tr			-	10	20	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			-	21	40	
Fall Time <sup>c</sup>	t <sub>f</sub>			-	8	20	
Source-Drain Diode Ratings and Char	acteristics T <sub>C</sub> = 2	25 °C <sup>b</sup>					
Pulsed Current <sup>a</sup>	I <sub>SM</sub>			-	-	-	Α
Forward Voltage	V <sub>SD</sub>	I <sub>F</sub> = 85 A, V <sub>GS</sub> = 0 V		-	-	-	V
Reverse Recovery Time	t <sub>rr</sub>			-	45	80	ns
Peak Reverse Recovery Current	I <sub>RM(REC)</sub>	I <sub>F</sub> = 2	-	-	-	Α	
Reverse Recovery Charge	Q <sub>rr</sub>	1		-	-	-	μC

#### Notes

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

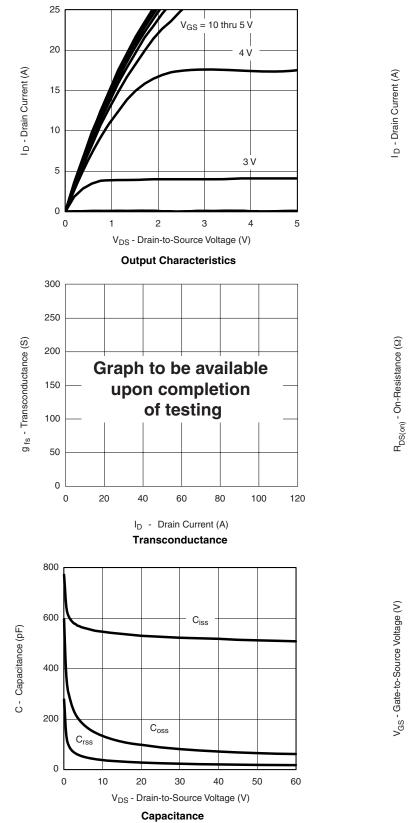
b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

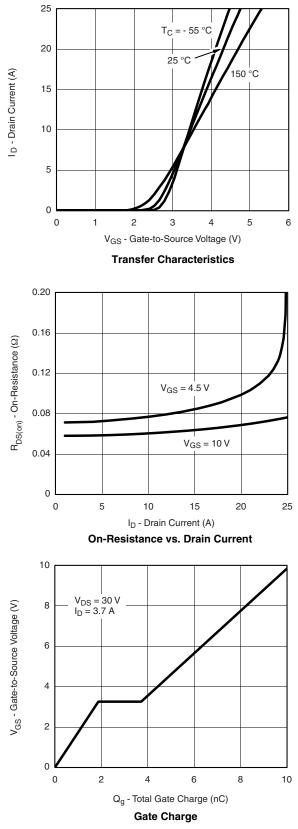


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## **TYPICAL CHARACTERISTICS** $T_A = 25$ °C, unless otherwise noted

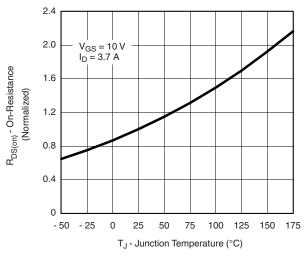
Document Number: 74499 S-81559-Rev. B, 23-Oct-08



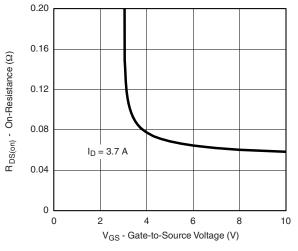
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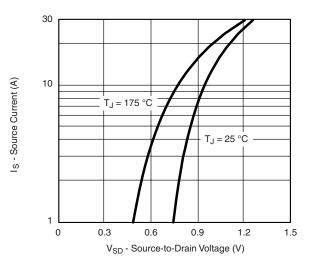
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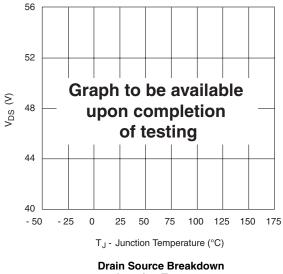
**On-Resistance vs. Junction Temperature** 



On-Resistance vs. Gate-to-Source Voltage



Source Drain Diode Forward Voltage

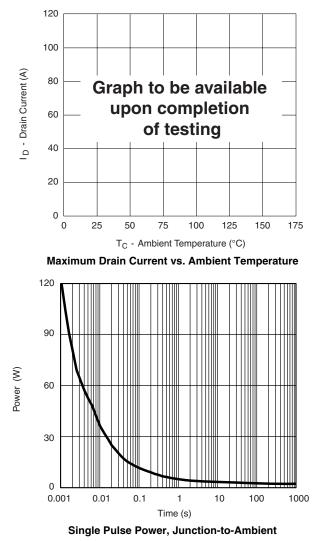


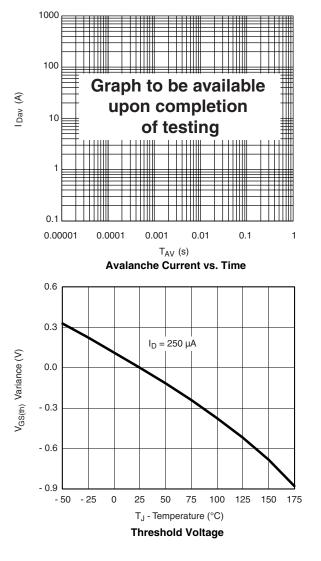
vs. Junction Temperature



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#### **THERMAL RATINGS** $T_A = 25$ °C, unless otherwise noted

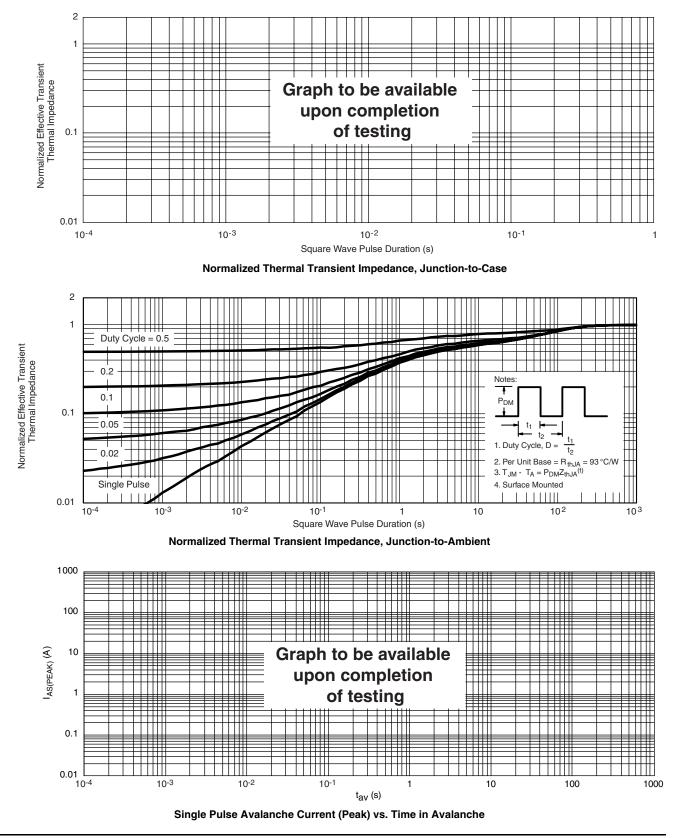




1000 100 I<sub>D</sub> - Drain Current (A) Graph to be available upon completion 10 of testing 1 0.1 0.1 10 100 1 V<sub>DS</sub> - Drain-to-Source Voltage (V) \* V<sub>GS</sub> > minimum V<sub>GS</sub> at which R<sub>DS(on)</sub> is specified Safe Operating Area



**THERMAL RATINGS**  $T_A = 25 \ ^{\circ}C$ , unless otherwise noted

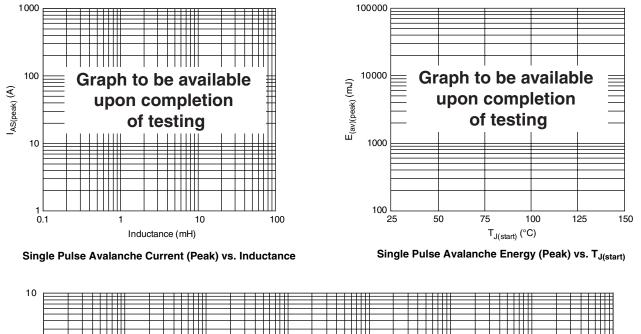


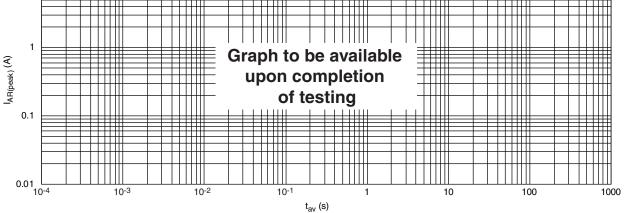
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### **THERMAL RATINGS** $T_A = 25$ °C, unless otherwise noted



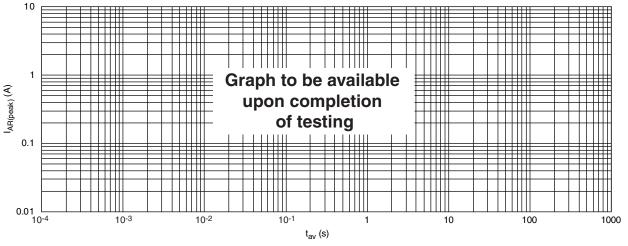


Repetitive Avalanche Current (Peak) vs. Time in Avalanche at  $T_A$  = 25 °C

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#### **THERMAL RATINGS** $T_A = 25 \text{ °C}$ , unless otherwise noted



Repetitive Avalanche Current (Peak) vs. Time in Avalanche at T<sub>A</sub> = 150 °C

#### Note

The characteristics shown in the six graphs

- Normalized Transient Thermal Impedance Junction to Ambient (25 °C)

- Single Pulse Avalanche Current (Peak) vs. Time in Avalanche

- Single Pulse Avalanche Current (Peak) vs. Inductance

- Single Pulse Avalanche Energy (Peak) vs. T<sub>J (start)</sub>

- Repetitive Avalanche Current (Peak) vs. Time in Avalanche at T<sub>A</sub> = 25 °C

- Repetitive Avalanche Current (Peak) vs. Time in Avalanche at  $T_A = 150$  °C

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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